

**In the Claims:**

1. (Currently Amended) A method of forming localized positive optical power units ~~in a substrate~~, comprising:  
forming a ~~master in the form of~~ first substrate that comprises photo-polymer or plastic material and includes a complement to a desired arrangement of localized positive optical power units ~~on a substrate~~; and  
molding a plurality of localized positive optical power units onto a second substrate using the master first substrate that comprises photo-polymer or plastic material as a mold for the second substrate.
2. (Currently Amended) The method of claim 1, wherein the ~~master~~ first substrate is designed using one of computer aided design or an optical ray tracing program.
3. (Currently Amended) The method of claim 2, wherein the ~~master~~ first substrate is manufactured using precision milling or is ground to form a press or planar mold.
4. (Currently Amended) The method of claim 1, wherein the ~~master is formed of plastic material~~ comprises a thermal plastic material which is hardened to retain its shape.
5. (Currently Amended) The method of claim ~~[[4]]~~ 1, wherein the ~~master is formed of photo-polymer material~~ comprises a photo-polymer that is polymerized with ultraviolet light.
6. (Currently Amended) The method of claim 1, wherein the ~~master~~ first substrate further comprises ~~a substrate having~~ a first layer comprising aluminum ~~deposited thereon~~ on the complement to the desired arrangement of localized positive optical power units and a second layer comprising nickel ~~deposited on the first layer~~.

7. (Currently Amended) The method of claim 1, wherein the ~~master~~ first substrate is configured to wrap around a cylinder or roller, which is then used to mold ~~[[a]] the plurality of bead-like projecting members~~ localized positive optical power units onto ~~[[a]]~~ the second substrate.

8. (Currently Amended) The method of claim 1, wherein ~~the step of~~ molding a plurality of localized positive optical power units onto a second substrate using the ~~master~~ first substrate comprises heating the ~~master~~ first substrate and then embossing a plurality of localized positive optical power units onto ~~[[a]]~~ the second substrate using the heated ~~master~~ first substrate.

9. (Canceled)

10. (Currently Amended) The method of claim ~~[[9]]~~ 1, wherein the localized positive optical power units comprise projecting members.

11. (Original) The method of claim 10, wherein the projecting members are spherical, or approximately spherical.

12. (Canceled)

13. (New) The method of Claim 1 wherein molding a plurality of localized positive optical power units onto a second substrate using the first substrate comprises molding a plurality of localized positive optical power units onto a second substrate that comprises photo-polymer or plastic material using the first substrate that comprises photo-polymer or plastic material as a mold for the second substrate.

14. (New) The method of Claim 13 wherein the second substrate comprises photo-polymer material, the method further comprising hardening the plurality of localized positive optical power units on the second substrate by photo-polymerization.

15. (New) The method of Claim 14 wherein hardening comprises hardening the plurality of localized positive optical power units on the second substrate by photo-polymerization with ultraviolet light.

16. (New) The method of Claim 5 wherein molding a plurality of localized positive optical power units onto a second substrate using the first substrate comprises molding a plurality of localized positive optical power units onto a second substrate that comprises photo-polymer or plastic material using the first substrate that comprises photo-polymer or plastic material as a mold for the second substrate.

17. (New) The method of Claim 16 wherein the second substrate comprises photo-polymer material, the method further comprising hardening the plurality of localized positive optical power units on the second substrate by photo-polymerization.

18. (New) The method of Claim 17 wherein hardening comprises hardening the plurality of localized positive optical power units on the second substrate by photo-polymerization with ultraviolet light.